

IS530.2 Smartphone Set ROW no camera 订货号 317279



- No camera
- universal, 13-pin ISM (multifunction) interface for connection of additional devices for many applications
- Android Enterprise Recommended
- zero touch capable
- MDM compatible

<STEPREF A="AT\_TitleWeb-shop" O="PV 2698953"



With its ISM interface, the powerful, explosion-protected industrial smartphone has many applications. Other additional modules such as an RSM, PTT headsets, the professional IS-TH1xx.1 barcode scanner and the IS-TC1A.1 thermal imaging camera make the IS530.1 smartphone a high-performance, multifunctional device. The smartphones are Android Enterprise Recommended, zero touch capable and MDM compatible.

技术数据

防爆

|                 |   |
|-----------------|---|
| 使用范围 ( 区 )      | 2<br>22   |
| 使用范围 (Division) | Class I, Division 2<br>Class II, Division 2<br>Class III, Division 2            |
| 应用范围            | 2 区 , 22 区  |
| 适用范围            | 欧盟 (CE / ATEX)<br>全球 (IECEX)<br>美国 (NEC)<br>加拿大 (CEC)<br>中国 (PCEC)<br>南非 (SANS) |
| IECEX 认证        | EPS 19.0033X  |
| ATEX 认证         | EPS 19 ATEX 1 070 X   |
| NEC 认证          | 70220252  |
| CEC 认证          | 70220252  |
| PCEC 认证         | CE20.2418X  |
| SANS 认证         | MTEX-S/22.0568 X  |
| IECEX 气体防爆      | Ex ic IIC T4 Gc IP64  |
| IECEX 粉尘防爆      | Ex ic IIIC T135°C Dc IP64   |
| ATEX 气体防爆       | Ⓜ II 3G Ex ic IIC T4 Gc IP64  |
| ATEX 粉尘防爆       | Ⓜ II 3D Ex ic IIIC T135°C Dc IP64   |
| NEC 气体防爆        | Class I, Div 2, Groups A, B, C, D, T4   |
| NEC 粉尘防爆        | Class II, Div 2, Groups F, G , T135°C<br>Class III, Div 2                       |
| CEC 气体防爆        | Class I, Div 2, Groups A, B, C, D, T4   |
| CEC 粉尘防爆        | Class II, Div 2, Groups F, G , T135°C<br>Class III, Div 2                       |

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|             |                                |
|-------------|--------------------------------|
| <b>防爆</b>   |                                |
| PCEC 气体防爆   | Ex ic IIC T4 Gc                |
| PCEC 粉尘防爆   | Ex icD 22 T135°C               |
| <b>电气数据</b> |                                |
| 处理器型号       | Qualcomm SDM660 Octa-core      |
| 内存          | 4 GB                           |
| 数据存储器       | 64 GB 内存 + 高达 128 GB 的 SD 卡    |
| 操作系统        | Android 10 (upgr. 13)          |
| 移动标准        | 2G, 3G, 4G                     |
| 介质接口        | WLAN 802.11 a/b/g/n/ac/e/k/r/h |
| 可选数据接口 1    | 蓝牙 5                           |
| SD 卡型号/容量   | microSD/最大 128 GB              |
| SIM 卡数量     | 双 SIM 卡                        |
| SIM 卡尺寸     | micro                          |
| <b>显示屏</b>  |                                |
| 显示屏尺寸, 英寸   | 4.50                           |
| 显示屏尺寸 cm    | 11.43                          |
| 显示屏分辨率      | FWVGA                          |
| 触摸屏         | 电容式                            |
| 触摸屏材料       | 大猩猩玻璃, 康宁第三代                   |
| 背光照明灯       | LED 技术                         |
| <b>环境条件</b> |                                |
| 环境温度        | -20 – 60                       |
| <b>机械数据</b> |                                |
| 防护等级 (IP)   | IP68                           |
| MIL 标准      | 810G ( h/l 温度, 冲击, 振动 )        |
| 宽度          | 80 mm                          |
| 高度          | 155 mm                         |
| 深度          | 25 mm                          |
| 重量          | 325 g                          |
| 重量          | 0.72 lb                        |

保留更改技术数据、尺寸、重量、结构和交付方式的权利。图片不具有法律约束力。